DDR Termination Regulator

General Description

The RT2568 is a sink/source tracking termination regulator. It is specifically designed for low-cost and low-external component count systems. The RT2568 possesses a high speed operating amplifier that provides fast load transient response and only requires a minimum 10μF x 3 ceramic output capacitor. The RT2568 supports remote sensing functions and all features required to power the DDRIII and Low Power DDRIII / DDRIV VTT bus termination according to the JEDEC specification. In addition, the RT2568 provides an open-drain PGOOD signal to monitor the output regulation and an EN signal that can be used to discharge VTT during S3 (suspend to RAM) for DDR applications.

The RT2568 is available in the thermal efficient package, WDFN-10L 3x3.

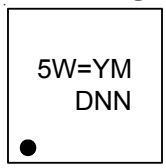
Features

- **VIN Input Voltage Range: 1.1V to 3.5V**
- **VCNTL Input Voltage Range: 2.9V to 5.5V**
- **Support Ceramic Capacitors**
- **Power Good Indicator**
- **10mA Source/Sink Reference Output**
- **Meet DDRI, DDRII JEDEC Spec**
- **Support DDRIII, Low Power DDRIII/DDRIV VTT Applications**
- **Soft-Start Function**
- **UVLO and OCP Protection**
- **Thermal Shutdown**

Applications

- Notebook/Desktop/Server
- Telecom/Datacom, GSM Base Station, LCD-TV/PDP-TV, Copier/Printer, Set-Top Box

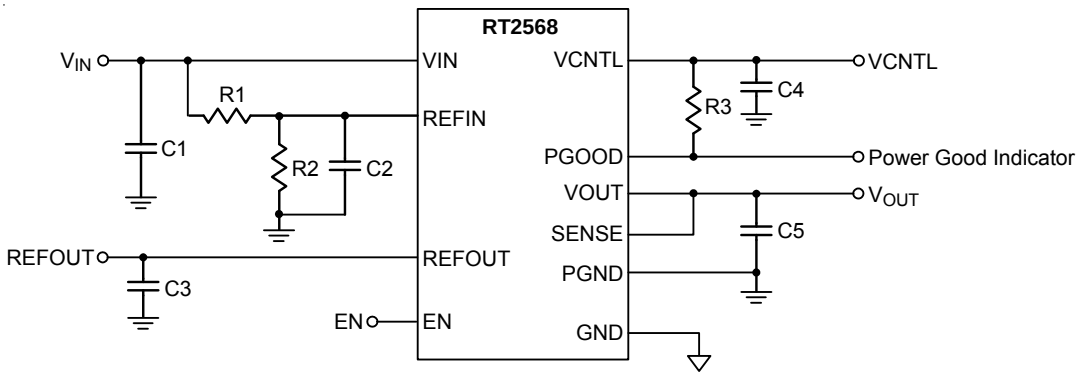
Marking Information



5W= : Product Code

YMDNN : Date Code

Simplified Application Circuit



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Ordering Information

RT2568□□

Package Type
QW : WDFN-10L 3x3 (W-Type)

Lead Plating System
G : Green (Halogen Free and Pb Free)

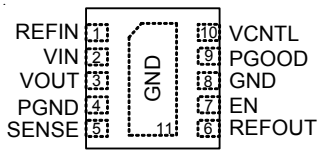
Note :

Richtek products are :

- RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- Suitable for use in SnPb or Pb-free soldering processes.

Pin Configurations

(TOP VIEW)



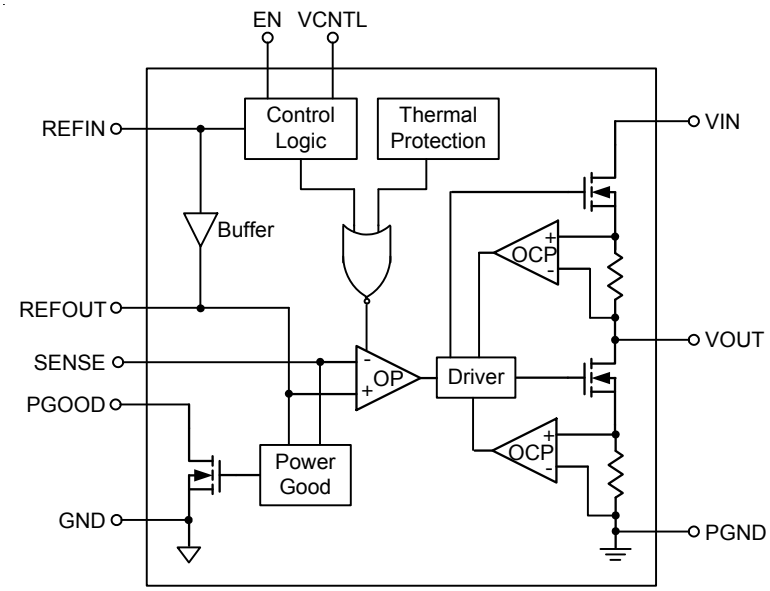
WDFN-10L 3x3

Functional Pin Description

Pin No.	Pin Name	Pin Function
1	REFIN	Reference Input.
2	VIN	Power Input of the Regulator.
3	VOUT	Power Output of the Regulator.
4	PGND	Power Ground of the Regulator.
5	SENSE	Voltage Sense Input for the Regulator. Connect to positive terminal of the output capacitor or the load.
6	REFOUT	Reference Output. Connect to GND through a 0.1μF ceramic capacitor.
7	EN	Enable Control Input. For DDR VTT application, connect EN to SLP_S3. For other applications, use EN as the ON/OFF function.
9	PGOOD	Power Good Open-Drain Output. Connect a pull-up resistor between this pin and VCNTL pin.
10	VCNTL	Control Voltage Input. Connect this pin to the 3.3V or 5V power supply. A ceramic decoupling capacitor with a value 4.7μF is required.
8, 11 (Exposed Pad)	GND	Analog Ground. Connect to negative terminal of the output capacitor. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.

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Function Block Diagram



Operation

The RT2568 is a linear sink/source DDR termination regulator with current capability up to 3A. The RT2568 builds in a high-side N-MOSFET which provides current sourcing and a low-side N-MOSFET which provides current sinking. All the control circuits are supplied by the power VCNTL. In normal operation, the error amplifier OP adjusts the gate driving voltage of the power MOSFET to achieve SENSE voltage well tracking the REFIN voltage.

Both the source and sink currents are detected by the internal sensing resistor, and the OCP function will work to limit the current to a designed value when overload happens. Furthermore, the current will be folded back to be one half if VOUT is out of the power good window.

Buffer

This function provides REFOUT output equal to REFIN with 10mA source/sink current capability.

Power Good

When the SENSE voltage is in the power good window and lasts for a certain delay time, then the PGOOD pin will be high impedance and the PGOOD voltage will be pulled high by the external resistor.

Control Logic

This block includes VCNTL UVLO, REFIN UVLO and Enable/Disable functions, and provides logic control to the whole chip.

Thermal Protection

Both the high-side and low-side power MOSFETs will be turned off when the junction temperature is higher than typically 160°C, and be released to normal operation when junction temperature falls below 120°C typically.

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Absolute Maximum Ratings (Note 1)

- Supply Voltage, VIN, VCNTL ---------- –0.3V to 6V
- Input Voltage, EN, REFIN, SENSE ---------- –0.3V to 6V
- Output Voltage, VOUT, REFOUT, PGOOD ---------- –0.3V to 6V
- Power Dissipation, P_D @ T_A = 25°C
  WDFN-10L 3x3 ---------- 2.5W
- Package Thermal Resistance (Note 2)
  WDFN-10L 3x3, θ_{JA} ---------- 40°C/W
  WDFN-10L 3x3, θ_{JC} ---------- 7.5°C/W
- Lead Temperature (Soldering, 10 sec.) ---------- 260°C
- Junction Temperature ---------- 150°C
- Storage Temperature Range ---------- –65°C to 150°C
- ESD Susceptibility (Note 3)
  HBM (Human Body Model) ---------- 2kV
  MM (Machine Model) ---------- 200V
  CDM (Charged Device Model) ---------- 2kV

Recommended Operating Conditions (Note 4)

- Control Input Voltage, VCNTL ---------- 2.9V to 5.5V
- Supply Input Voltage, VIN ---------- 1.1V to 3.5V
- Junction Temperature Range ---------- –40°C to 125°C

Electrical Characteristics

(V_{IN} = 1.5V, V_{EN} = V_{CNTL} = 3.3V, V_{REFIN} = V_{SENSE} = 0.75V, C_{OUT} = 10µF x 3, T_A = –40°C to 85°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Supply Current						
VCNTL Supply Current	I_{VCNTL}	V_{EN} = V_{CNTL}, No Load	--	0.7	1	mA
VCNTL Shutdown Current	I_{SHDN_VCNTL}	V_{EN} = 0V, V_{REFIN} = 0V, No Load	--	65	80	µA
		V_{EN} = 0V, V_{REFIN} > 0.4V, No Load	--	200	400	
VIN Supply Current	I_{VIN}	V_{EN} = V_{CNTL}, No Load	--	1	50	µA
VIN Shutdown Current	I_{SHDN_VIN}	V_{EN} = 0V, No Load	--	0.1	50	µA
Output						
VTT Output Voltage	V_{OUTO}	V_{IN} = 1.5V, V_{REFIN} = 0.75V, I_{OUT} = 0A	--	0.75	--	V
		V_{IN} = 1.35V, V_{REFIN} = 0.675V, I_{OUT} = 0A	--	0.675	--	
		V_{IN} = 1.2V, V_{REFIN} = 0.6V, I_{OUT} = 0A	--	0.6	--	
VTT Output Voltage Offset	V_{OUT_OS}	I_{OUT} < ±2A, V_{LDOIN} = 1.5V, V_{OUT_OS} = V_{OUT} – V_{OUTO}	–25	--	25	mV
		I_{OUT} < ±2A, V_{LDOIN} = 1.35V, V_{OUT_OS} = V_{OUT} – V_{OUTO}	–25	--	25	
		I_{OUT} < ±2A, V_{LDOIN} = 1.2V, V_{OUT_OS} = V_{OUT} – V_{OUTO}	–25	--	25	

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Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
VOUT Source Current Limit	$I_{LIM_VOUT_SR}$	VOUT in PGOOD Window	3	4.5	--	A
VOUT Sink Current Limit	$I_{LIM_VOUT_SK}$	VOUT in PGOOD Window	3	4.5	--	A
VOUT Discharge Resistance	$R_{DISCHARGE}$	V_{REFIN} = 0V, V_{OUT} = 0.3V, V_{EN} = 0V	--	18	25	Ω
Power Good Comparator						
PGOOD Threshold	V_{TH_PGOOD}	V_{SENSE} lower threshold with respect to REFOUT	--	–20	--	%
		V_{SENSE} upper threshold with respect to REFOUT	--	20	--	
		PGOOD Hysteresis	--	5	--	
PGOOD Start-Up Delay	$T_{PGDELAY1}$	Start-up rising delay, V_{SENSE} within PGOOD range	--	2	--	ms
Output Low Voltage	V_{LOW_PGOOD}	I_{PGOOD} = 4mA	--	--	0.4	V
PGOOD Falling Delay	$T_{PGDELAY2}$	Falling delay, V_{SENSE} is out of PGOOD range	--	10	--	μs
Leakage Current	$I_{LEAKAGE_PGOOD}$	V_{SENSE} = V_{REFIN} (PGOOD high impedance), V_{PGOOD} = V_{CNTL} + 0.2V	--	--	1	μA
REFIN and REFOUT						
REFIN Input Current	I_{REFIN}	V_{EN} = V_{CNTL}	--	--	1	μA
REFIN Voltage Range	V_{REFIN}		0.5	--	1.8	V
REFIN Under-Voltage Lockout	V_{UVLO_REFIN}	REFIN Rising	360	390	420	mV
		Hysteresis	--	20	--	
REFOUT Voltage Tolerance to VREFIN	V_{TOL_REFOUT}	–10mA < I_{REFOUT} < 10mA, V_{REFIN} = 0.75V	–15	--	15	mV
		–10mA < I_{REFOUT} < 10mA, V_{REFIN} = 0.675V	–15	--	15	
		–10mA < I_{REFOUT} < 10mA, V_{REFIN} = 0.6V	–15	--	15	
REFOUT Source Current Limit	$I_{LIM_REFOUT_SR}$	V_{REFOUT} = 0V	10	40	--	mA
REFOUT Sink Current Limit	$I_{LIM_REFOUT_SK}$	V_{REFOUT} = REFIN + 1V	10	40	--	mA
UVLO/EN						
UVLO Threshold	V_{UVLO_VCNTL}	Rising	2.5	2.7	2.85	V
		Hysteresis	--	120	--	mV
EN Input Voltage — Logic-High	V_{IN_H}		1.7	--	--	V
EN Input Voltage — Logic-Low	V_{IN_L}		--	--	0.3	
Thermal Shutdown						
Thermal Shutdown Threshold	T_{SD}	Shutdown Temperature (Note 5)	--	160	--	°C
		Hysteresis (Note 5)	--	15	--	

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Note 1. Stresses beyond those listed “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

Note 2. θ_{JA} is measured at T_A = 25°C on a high effective thermal conductivity four-layer test board per JEDEC 51-7. θ_{JC} is measured at the exposed pad of the package.

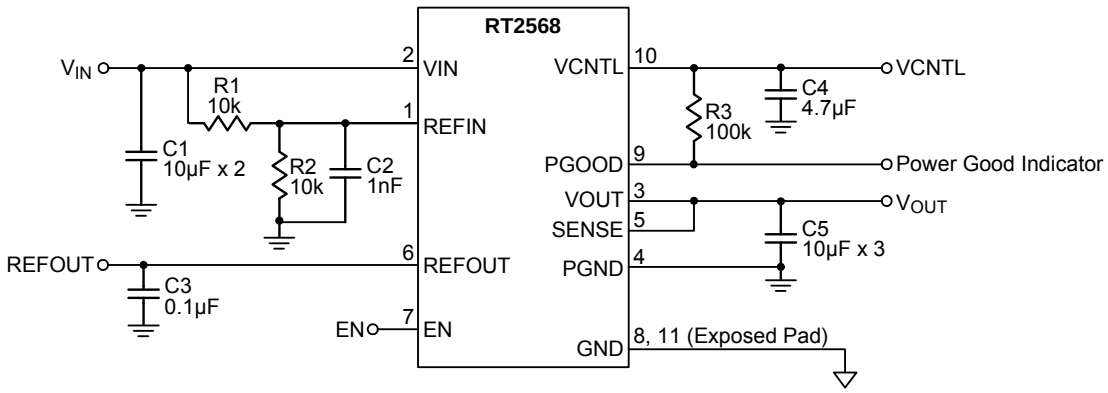
Note 3. Devices are ESD sensitive. Handling precaution is recommended.

Note 4. The device is not guaranteed to function outside its operating conditions.

Note 5. Guarantee by design.

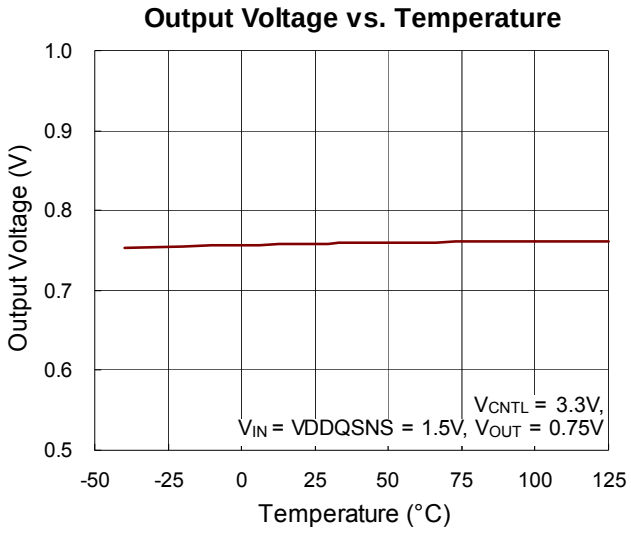
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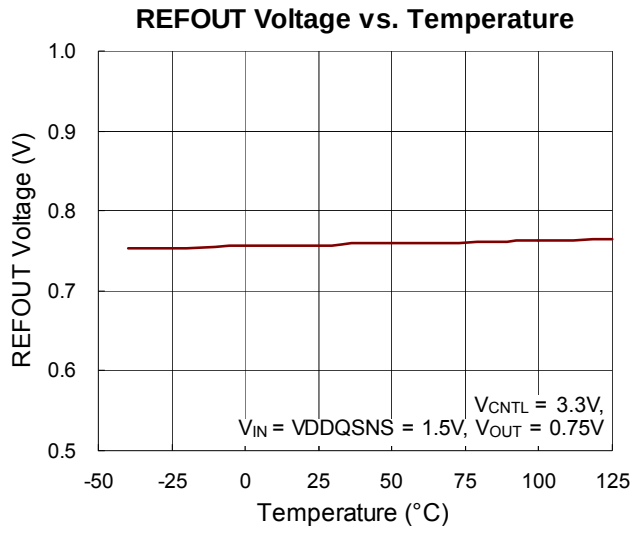
Typical Application Circuit

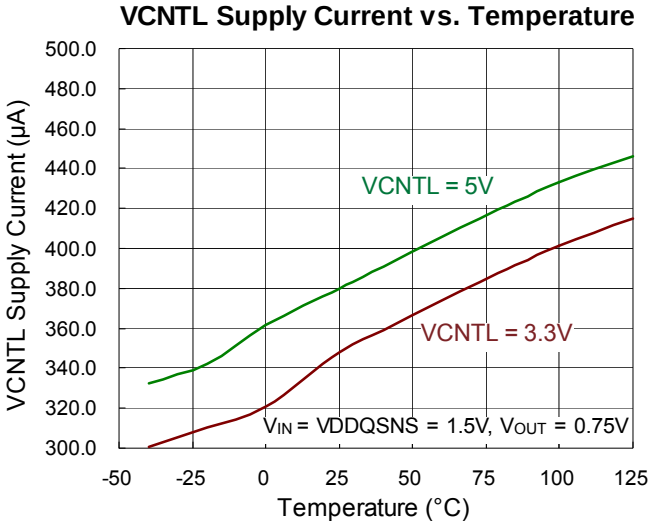


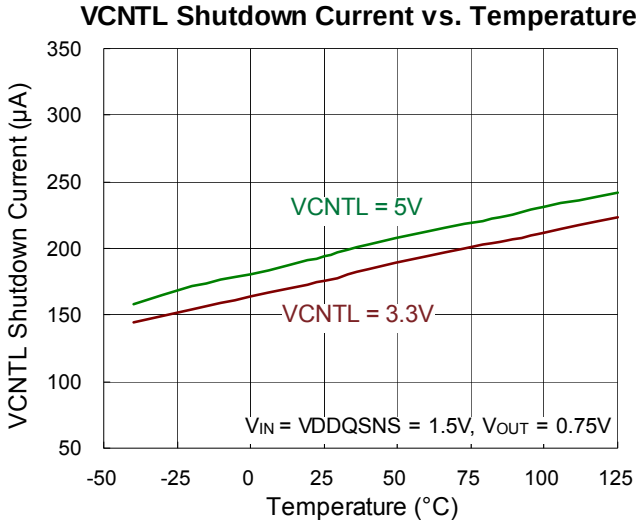
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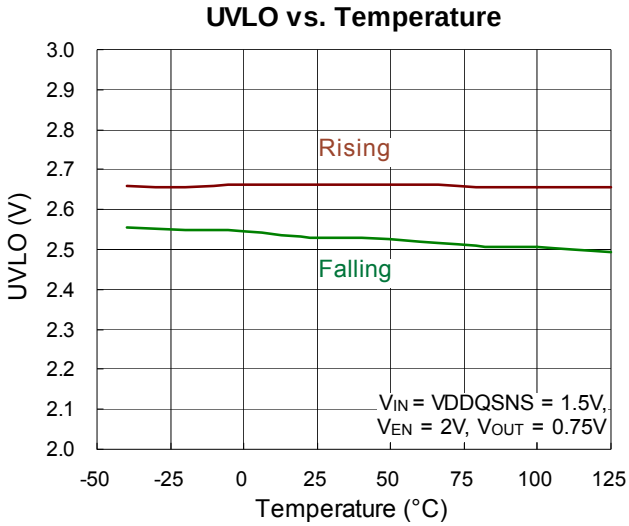
Typical Operating Characteristics

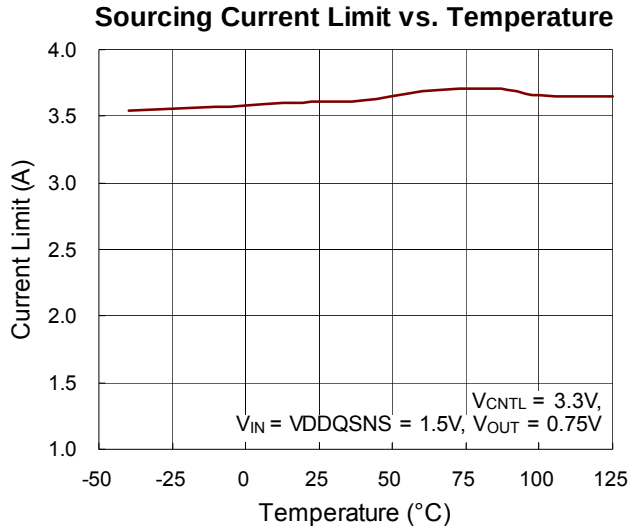






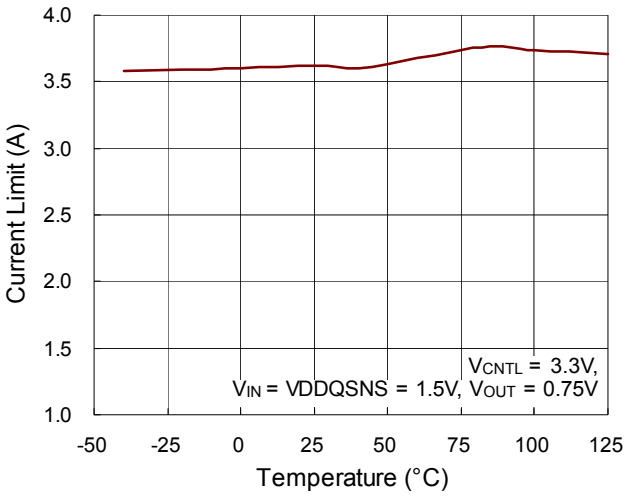




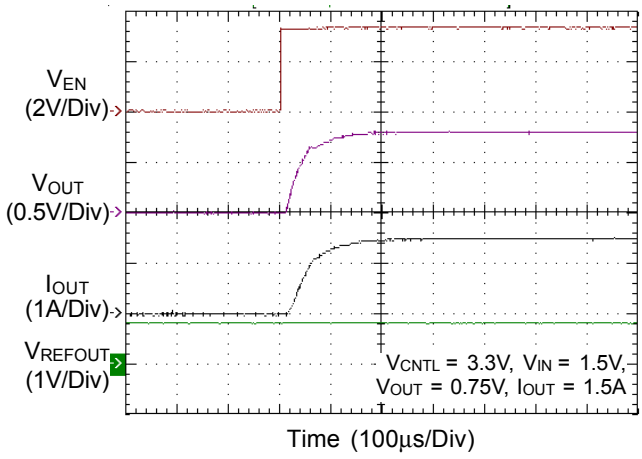


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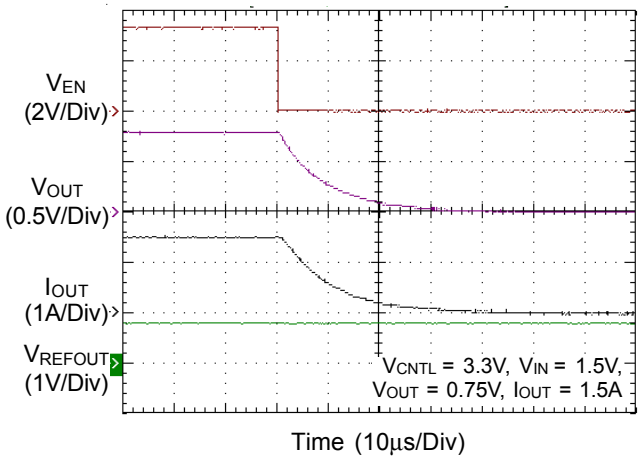
Sinking Current Limit vs. Temperature



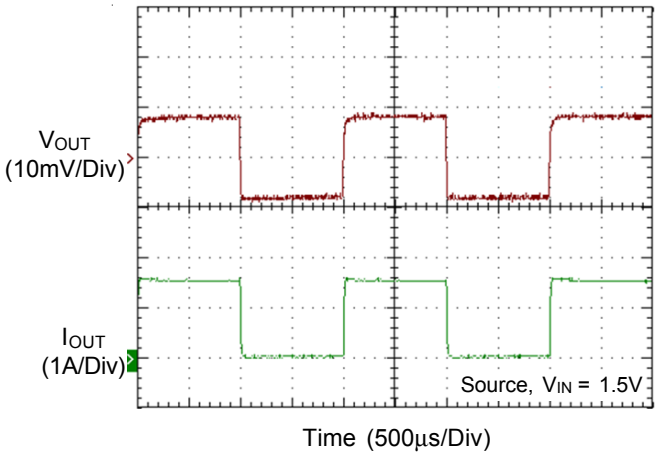
Power On from EN



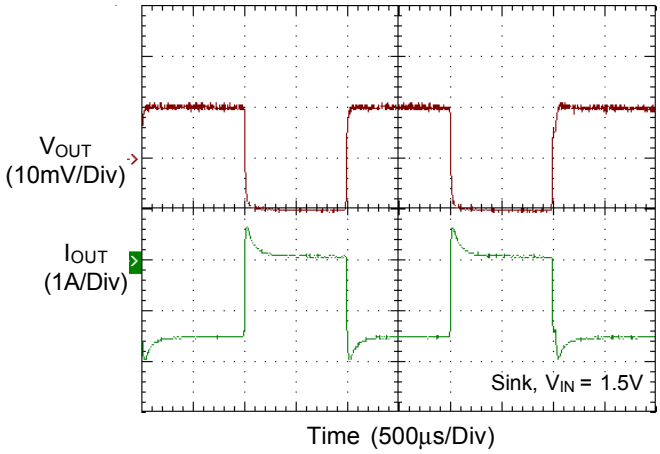
Power Off from EN



0.75V_{OUT} @ 1.5A Transient Response



0.75V_{OUT} @ 1.5A Transient Response



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Application Information

The RT2568 is a 3.5A sink/source tracking termination regulator. It is specifically designed for low-cost and low-external component count system such as notebook PC applications. The RT2568 possesses a high speed operating amplifier that provides fast load transient response and only requires two 10μF ceramic input capacitors and three 10μF ceramic output capacitors.

Capacitor Selection

Good bypassing is recommended from VLDOIN to GND to help improve AC performance. A 10μF or greater input capacitor located as close as possible to the IC is recommended. The input capacitor must be located at a distance of less than 0.5 inches from the VLDOIN pin of the IC.

Adding a 1μF ceramic capacitor close to the VIN pin and it should be kept away from any parasitic impedance from the supply power. For stable operation, the total capacitance of the ceramic capacitor at the VTT output terminal must be larger than 30μF. The RT2568 is designed specifically to work with low ESR ceramic output capacitor in space saving and performance consideration. Larger output capacitance can reduce the noise and improve load transient response, stability and PSRR. The output capacitor should be located near the VTT output terminal pin as close as possible.

Thermal Considerations

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula :

$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction to ambient thermal resistance.

For recommended operating condition specifications, the maximum junction temperature is 125°C. The junction to ambient thermal resistance, θ_{JA}, is layout dependent. For WDFN-10L 3x3 package, the thermal resistance, θ_{JA}, is 40°C/W on a standard JEDEC 51-7 four-layer thermal test board. The maximum power dissipation at T_A = 25°C can be calculated by the following formula :

$P_{D(MAX)}$ = (125°C – 25°C) / (40°C/W) = 2.5W for WDFN-10L 3x3 package

The maximum power dissipation depends on the operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance, θ_{JA}. The derating curve in Figure 1 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

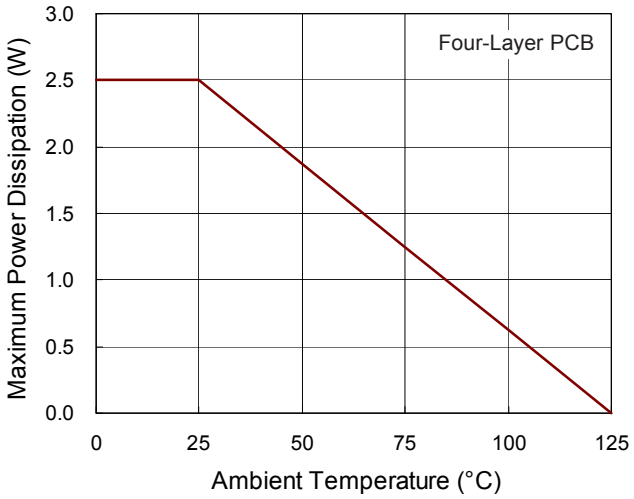
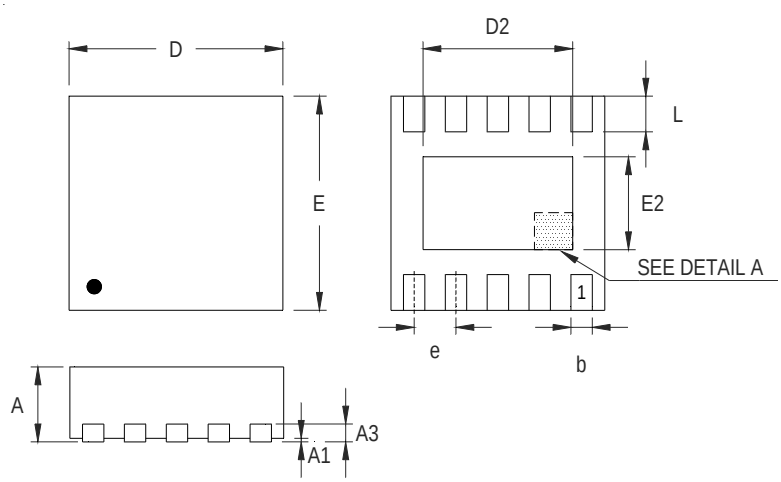
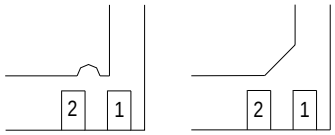


Figure 1. Derating Curve of Maximum Power Dissipation

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Outline Dimension





DETAIL A

Pin #1 ID and Tie Bar Mark Options

Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.175	0.250	0.007	0.010
b	0.180	0.300	0.007	0.012
D	2.950	3.050	0.116	0.120
D2	2.300	2.650	0.091	0.104
E	2.950	3.050	0.116	0.120
E2	1.500	1.750	0.059	0.069
e	0.500		0.020	
L	0.350	0.450	0.014	0.018

W-Type 10L DFN 3x3 Package

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